# CST5006A OTP-type Speech IC

# 1. CST5006A General Descriptions

CST5006A series are 4-bits micro-controller which could play 4 channel melody or 4 channel ADPCM with PWM direct drive circuit. PWM resolution is 8/10/12 bits. They includes a low cost, high performance CMOS micro-processor. The clock frequency of this up is typically 8.192 (±3%) MHz. This chip operates over a wide voltage range of 2.0V~5.5V. It contains program ROM (PROM) and data ROM (DROM) inside. The maximum program ROM is 4K words and maximum data ROM size is 33K byte. The maximum working SRAM is (64+2) nibbles. It is provided with total 4 software programmable I/O Ports.

#### 2. CST5006A Features

- Operating voltage: 2.0V to 5.5V
   MCU Operation frequency: 8.192MHz
- Memory Size
- □ Program ROM size: 4K\*12-bits OTP type
   □ Data ROM size: 18K\*8-bits OTP type
- □ SRAM size: 64\*4 bits
  □ User register: 2\*4 bits
- Wakeup function for power-down mode:
- ☐ HALT mode wakeup source: Port A can wake-up from HALT mode to NORMAL mode and executing wake-up sub-routine program.
- 4 input/output pins: Port A can be defined as input or output port bit by bit.
- Three reset condition:
  - ☐ Low voltage reset. (LVR = 2.0V)
  - $\ \square$  Power on reset.
  - □ Watch dog timer overflow.
- One internal interrupt sources:
  - □ PWM interrupt.
- WDT
  - □ Watch dog timer, can enabled/disabled by option.
  - □ WDT period is 256\*256\*16/Fsys. (WDT period is 0.13 sec for system clock=8.192MHz)
- Audio output:
  - □ Support PWM or DAC mode by option.
  - □ Support 8/10/12 bits.
- Support option set for pull down resistor 1M, 50K or 220K Ohm, low voltage reset...etc.
- Oscillator fuse option ±3%, temperature & voltage compensation.
- Support **security option (1 bit)** for read inhibition.
- Support 16-levels LVD function.



# 3. CST5006A Packaging and Pads Information

#### 3.1 Pads

| PAD Name           | Type | State After Reset | Description                                 |  |  |  |  |  |  |  |  |
|--------------------|------|-------------------|---|--|--|--|--|--|--|--|--|
| Reset, Power Input |      |                   |   |  |  |  |  |  |  |  |  |
| VCC                | Ρ    | High              | Power input of I/O port.                    |  |  |  |  |  |  |  |  |
| VSS                | Р    | Low               | Ground input except PWM block power.        |  |  |  |  |  |  |  |  |
|                    |      |                   | It could be double bonded with VPS pad.     |  |  |  |  |  |  |  |  |
| VPD                | Р    | High              | PWM block power input in normal operation.  |  |  |  |  |  |  |  |  |
| VPS                | Р    | Low               | The ground pad of PWM block.                |  |  |  |  |  |  |  |  |
|                    |      |                   | It could be double bonded with VSS pad.     |  |  |  |  |  |  |  |  |
| General I/O ports  | 1    |                   |   |  |  |  |  |  |  |  |  |
| PA3~PA0            | I/O  | ZZZZ              | Port A is a programmable input/output port. |  |  |  |  |  |  |  |  |
| Audio output pads  |      |                   |   |  |  |  |  |  |  |  |  |
| PWMP               | 0    | Low               | Audio output PWM(+).                        |  |  |  |  |  |  |  |  |
| PWMN               | 0    | Low               | Audio output PWM(-).                        |  |  |  |  |  |  |  |  |

Table 1: Pad Description

# 3.2 Package

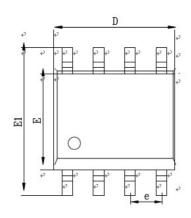
CST5006A provides SOP8

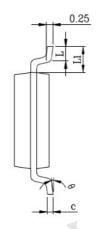




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# 3.2.1 SOP8





| *C     | Dimensions I | n Millimeters |
|--------|--------------|---------------|
| Symbol | Min          | Max           |
| Α      | 1.35         | 1.75 +        |
| * A1   | 0.10         | 0,23          |
| A2     | 1.30         | 1.50          |
| * b    | 0.39         | 0.45          |
| C      | 0.21         | 0.26          |
| D      | 4.70         | 5.10          |
| E      | 3.70         | 4.10          |
| * E1   | 5.80         | 6.20          |
| ж е    | 1.24         | 1.30          |
| * .L   | 0.50         | 0,80          |
| * L1   | 0.99         | 1.10          |
| - θ    | 0.           | 8.            |

注:1.標注"\*"尺寸爲測量尺寸₽

# 3.3 Block Diagram

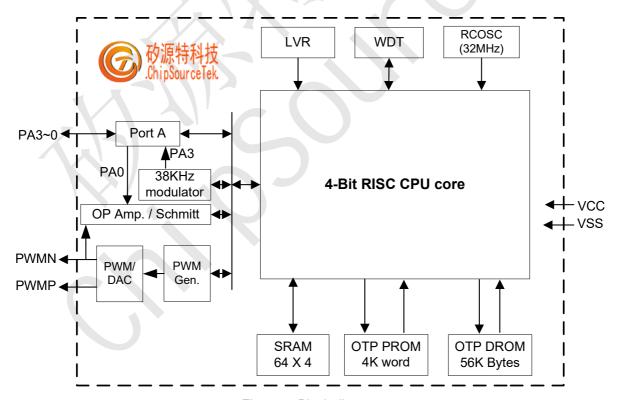


Figure 1. Block diagram



#### 4. CST5006A ELECTRICAL CHARACTERISTICS

# 4.1 Absolute Maximum Ratings

| Parameters                  | Symbol | Value           | Unit                 |
|-----------------------------|--------|-----------------|----------------------|
| DC Supply Voltage           | Vcc    | -0.5 to 6.0     | <b>V</b>             |
| Input Voltage               | Vin    | -0.5 to Vcc+0.5 | V                    |
| Operating Temperature Range | Ta     | 0 to +75        | $^{\circ}\mathbb{C}$ |
| Storage Temperature Range   | Tstg   | -25 to +85      | $^{\circ}$           |

Table 2: Absolute Maximum Ratings

# 4.2 AC Characteristics

VCC=3.0V, Ta=25°C unless otherwise noted.

| Parameters                          | Symbol | Minimum  | Typical   | Maximum |
|-------------------------------------|--------|----------|-----------|---------|
| Operating Frequency( RC Oscillator) | Fsys   | 7.946MHz | 8.192 MHz | 8.43MHz |
| RC reset time-constant              | Trrc   | -        | 10 us     | -       |
| Data ROM data ready time            | Tdrr   | -        | -         | 2/Fsys  |

Table 3: AC Characteristics



#### 4.3 DC Characteristics

VCC=3.0V, Ta=25°C unless otherwise noted.

| Parameters   | Symbol            | Minimum      | Typical  | Maximum  | Condition                                   |
|--|-------------------|--------------|----------|----------|---|
| Power supply range                                 | Vcc               | 2.0 V        | -        | 5.5 V    |   |
| OTP Programming Power                              | Vpp               | 9.5 V        | 10 V     | 10.5 V   | VCC = 4.8V                                  |
| Supply current                                     | lop               |              | 5mA      |          | System clock 8.192MHz<br>PWM disabled       |
| Stand-by Current                                   | I <sub>STBY</sub> |              | 3uA      |          | VCC=5.0V, MCU halt<br>System clock off      |
| Input high voltage                                 | Vih               |              | 0.55 VCC |          |   |
| Input low voltage                                  | Vil               |              | 0.55 VCC |          |   |
| Input leakage current                              | llk               |              | 0.1 uA   |          |   |
| Output high voltage                                | Voh               | 0.95 VCC     |          |          | no load                                     |
| Output low voltage                                 | Vol               |              |          | 0.05 V   | no load                                     |
| Output high current in high source capacity mode   | loh0              |              | 20mA     |          | Vout=2.0 all ports High source capacity     |
| Output low current in high sink capacity mode      | lol0              |              | 20mA     | V.       | Vout=1.0 all ports High sink capacity       |
| Output high current in normal source capacity mode | loh1              |              | 4mA      |          | Vout=2.0 all ports Normal source capacity   |
| PWM output load                                    |                   | 4-7          |          | 8 ohm    | Speaker impedance                           |
| Pull-down resistance #1                            | Rpd1              | \-\ <u>\</u> | 50K Ohm  | <u>-</u> | PA pins with pull-down Vin=3.0V             |
| Pull-down resistance #2                            | Rpd2              | X//          | 220K Ohm |          | PA pins with pull-down Vin=3.0V             |
| Pull-down resistance #3                            | Rpd3              |              | 1M Ohm   |          | PA pins with pull-down Vin=3.0V             |
| Threshold voltage of low voltage reset circuit     | Vlvr              |              | 2.0V     |          | Low voltage reset circuit can't be disabled |

Table 4: DC Characteristics

#### 5. CST5006A FUNCTIONAL DESCRIPTION

This chapter describes the function of MCU.

# 5.1 Program ROM (PROM)

The PROM is an OTP (One Time Programmable) type memory. The PROM is 4K\*12-bits (0000H ~ 1FFFH) which stores execution program. The last 256 location of effective PROM is reserved area, the user shall not use this area in any case. Assembler shall check user program on this limit. Hardware does not need to check this restriction.

In order to reserved unused area of PROM. These regions maybe use in the future. There is one option "OTPREV" for this purpose. If all unused area of PROM wanted to fill with "0xFFF", the option "OTPREV" on IDE tool must be enabled. Otherwise, they will fill with "0x000".

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| PROM address  | Function description |
|---------------|----------------------|
| 0x000 ~ 0x001 | Reset                |
| 0x004 ~ 0x005 | Wake-up              |
| 0x008 ~ 0x009 | Interrupt            |
| 0x00A ~ 0xEFF | User code            |
| 0xF00 ~ 0xFFF | Reserve area         |

Table 3: Memory Map of PROM

# 5.2 Data ROM (DROM)

The DROM is an OTP (One Time Programmable) type memory. The maximum DROM is 18K\*8-bits which stores the 8-bits wide data for ADPCM or melody data ...etc. The last 64 location is a reserved area. The user shall not use this area in any case. Assembler shall check user data ROM on this limit. Hardware does not need to check this restriction.

| DROM address (DMA) | Function description                        |
|--------------------|---|
| 0x0000 ~ 0x00FF    | User area                                   |
| 0x0100 ~ 0x01FF    | User area                                   |
| 0x0200 ~ 0x02FF    | User area                                   |
|                    | W.  |
| 0x47B0 ~ 0x47BF    | User area (Max. size of CST5006A)           |
| 0x47C0 ~ 0x47FF    | System area, last 64 location(don't use it) |

Table 4: Memory Map of DROM

DROM is addressed by four registers DMA3, DMA2, DMA1 and DMA0. After these registers are specified by software, the data need enough delay time, Tdrr in the table of "AC Characteristics". After this delay time, the data can be read from data register (DMDL & DMDH).

Ex:

LD (DMA0), A

LD (DMA3), A

Set DMA0~3

A, (DMDL) Read low nibble data from DROM, address as DMA3~0. LD ; Read high nibble data from DROM, address as DMA3~0. LD A, (DMDH)

| Symbol | Addr | R/W<br>type | Reset | D3     | D2     | D1     | D0     | Description  |
|--------|------|-------------|-------|--------|--------|--------|--------|--|
| DMA0   | 18H  | R/W         | XXXX  | DMA0.3 | DMA0.2 |        |        | DMA0~3, four register built a 16-bits addressing   |
| DMA1   | 19H  | R/W         | XXXX  | DMA1.3 | DMA1.2 | DMA1.1 | DMA1.0 | space for read DROM 8-bits data.   |
| DMA2   | 1AH  | R/W         | XXXX  | DMA2.3 | DMA2.2 | DMA2.1 | DMA2.0 | DMA0 is lowest nibble, DMA3 is highest nibble of   |
| DMA3   | 1BH  | R/W         | XXXX  | DMA3.3 | DMA3.2 | DMA3.1 | DMA3.0 | DROM address.  |
| DMDL   | 1CH  | R/W         | xxxx  | DMDL.3 | DMDL.2 | DMDL.1 | DMDL.0 | Low nibble of DROM data read from this address.  |
| DMDH   | 1DH  | R/W         | xxxx  | DMDH.3 | DMDH.2 | DMDH.1 | DMDH.0 | High nibble of DROM data read from this address. Write this register means reset watch dog timer if this timer is enabled by option. |

Table 5: SFRs about DROM

# 5.3 SRAM and Special Function Register

#### 5.3.1 SRAM

There are 64 nibbles SRAM in this chip. The SRAM and I/O memory map is divided into several pages by setting MAH register (1-bit wide). The initial value of MAH is unknown and must be defined by instructions "LDMAH" before you utilize SRAM. The extra 2 SRAM nibbles in the specifications and hardware manuals of relative mask ROM products are not SRAM in fact. They are USER1 and USER2 of SFRs.

| Direct Add | dressing | SRAM MAP                                |
|------------|----------|---|
| MAH=XH     | 00H~1FH  | SFR(special function register) register |
| MAH=0H     | 20H~3FH  | USER SRAM                               |
| MAH=1H     | 20H~3FH  | USEN SNAW                               |

Table 6: Memory Map of SFRs

The first 32-nibble, 00H ~ 1FH, are defined as a common block. Some I/O and user register is arranged in this common block for easy data operations. The other regions, 20H~3FH, are employed as SRAM. The user must notice that the initial content of SRAM is unknown.

# 5.3.2 Special Function Registers

The special function register consists of common I/O and other special register.

A special function register supports LD/ADC/SBC/OR/AND/XOR/INC/DEC/RLC/RRC/CMP/ADR operation.

Bit set/clear can only be operated on the address range from 00H to 0FH, except indirect operation is used. The following table describes all of the SFRs.

| Symbol   | Addr        | R/W<br>type | Reset | D3       | D2       | D1       | D0       | Description  |
|----------|-------------|-------------|-------|----------|----------|----------|----------|--|
| STATUS   | 00H         | R/W         | 00xx  | reserved | PWFG     | CF       | ZF       | Status Register PWFG: PWM interrupt flag. CF: Carry flag. ZF: Zero flag.   |
| Reserved | 01H         | -           | XXXX  | ·        |          | -        | -        | Reserved   |
| IOC_PA   | 02H         | R/W         | 0000  | IOCA3    | IOCA2    | IOCA1    | IOCA0    | "1" = output, "0" = input of related PA bit.   |
| DATA_PA  | 03H         | R/W         | xxxx  | DPA3     | DPA2     | DPA1     | DPA0     | Read from Port A input port and write to output port.  |
| Reserved | 04H~<br>06H |             | xxxx  | -        |          |          | -        | Reserved   |
| USER1    | 07H         | R/W         | XXXX  | USER1.3  | USER1.2  | USER1.1  | USER1.0  | General purpose user register.   |
| AUD_DLL  | 08H         | W           | xxxx  | AUD_DLL3 | AUD_DLL2 | AUD_DLL1 | AUD_DLL0 | AUD_DLL[3:2]: The bit1~0 of 10-bits PWM, combine with AUD_DL[3:0], AUD_DH[3:0] to built 10-bits PWM if option PWM10 is 1 and PWM12 is 0. AUD_DLL[3:0]: The bit3~0 of 12-bits PWM, combine with AUD_DL[3:0], AUD_DH[3:0] to built 12-bits PWM if option PWM12 is 1. |
| PWM_CTRL | 09H         | R/W         | x0    | reserved | reserved | ENINT    | ENPWM    | ENPWM: "1" Enable PWM, "0" Disable PWM.<br>ENINT: Enable global interrupt.   |
| AUD_DL   | 0AH         | W           | xxxx  | AUD_DL3  | AUD_DL2  | AUD_DL1  | AUD_DL0  | AUD_DL[3:0]: The low nibble of 8-bits PWM. The bit5~2 of 10-bits PWM. The bit7~4 of 12-bits PWM.   |



| AUD_DH   | овн         | W   | xxxx | AUD_DH3 | AUD_DH2  | AUD_DH1         | AUD_DH0 | AUD_DH[3:0]: The high nibble of 8 bits PWM. The bit9~6 of 10 bits PWM. The bit11~8 of 12 bits PWM. Note: AUD_DH3 is sign bit, "0" means positive.   |
|----------|-------------|-----|------|---------|----------|-----------------|---------|---|
| Reserved | 0CH~<br>0EH | -   | xxxx | -       | -        | -               | -       | Reserved  |
| USER2    | 0FH         | R/W | XXXX | USER2.3 | USER2.2  | USER2.1         | USER2.0 | General purpose user register.  |
| IADJ     | 10H         | R/W | 0000 | CMPSEL1 | CMPSEL0  | ADJ1            | ADJO    | CMPSEL[1:0]: Enable option PCEIO, ENOP, ENCMP1, and set ENGAIN=1, Select Gain in record mode.  CMPSEL[1:0] GAIN  00 50  01 100  10 150  11 200  ADJ[1:0]: Adjust the frequency, when enable option OTPADJ.  ADJ[1:0] Frequency %  00 -4%  01 -2%  10 2% |
| CNTI     | 11H         | R/W | 0000 | ENGAIN  |          | S2S             |         | 11 4%  ENGAIN: 1: Open Built-in gain in record mode. 0: Close Built-in gain in record mode. S2S: PWM input Data format 1: 2's format 0: sign Notice: If ENGAIN enabled, option OPEN function should be disable.   |
| PWMWK    | 12H         | R/W | 0000 | PWMWKFG | CLAPSEL1 | CLAPSEL0        | PWMWKEN | CLAPSEL[1:0]: Sensitivity of speaker wakeup.  CLAPSEL[1:0] Sensitivity  00 Level 1 (low)  01 Level 2  10 Level 3  11 Level 4 (High)   |
| LVD_CTRL | 13H         | R/W | 0000 | -       | -        | LVD_FLAG<br>(R) | LVDEN   | LVD_FLAG: (Read only) The flag of LVD, '1'=LVD sensing. LVDEN: '1'=Enable LVD function, '0'=Disable LVD function.   |
| LVDS     | 14H         | R/W | 0000 | LVDS3   | LVDS2    | LVDS1           | LVDS0   | LVDS[3:0]: LVD level selected,<br>1111=3.8V, 1110=3.7V, 1101=3.6V, 1100=3.4V,<br>1011=3.3V, 1010=3.2V, 1001=3.1V, 1000=3.0V,<br>0111=2.9V, 0110=2.8V, 0101=2.7V, 0100=2.5V,<br>0011=2.4V, 0010=2.3V, 0001=2.2V, 0000=2.1V.                              |
| Reserved | 15H~<br>17H | -   | xxxx |         | -        | -               | -       | Reserved  |
| DMA0     | 18H         | R/W | XXXX | DMA0.3  | DMA0.2   | DMA0.1          | DMA0.0  | DMA0~3, four register built a 16-bits addressing  |
| DMA1     | 19H         | R/W | XXXX | DMA1.3  | DMA1.2   | DMA1.1          | DMA1.0  | space for read DROM 8-bits data, DMA0 is  |

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| DMA2     | 1AH         | R/W | XXXX | DMA2.3 | DMA2.2 | DMA2.1 | DMA2.0 | lowest nibble, DMA3 is highest nibble of DROM  |
|----------|-------------|-----|------|--------|--------|--------|--------|--|
| DMA3     | 1BH         | R/W | XXXX | DMA3.3 | DMA3.2 | DMA3.1 | DMA3.0 | address.   |
| DMDL     | 1CH         | R/W | xxxx | DMDL.3 | DMDL.2 | DMDL.1 | DMDL.0 | Low nibble of DROM data read from this address.  |
| DMDH     | 1DH         | R/W | xxxx | DMDH.3 | DMDH.2 | DMDH.1 | DMDH.0 | High nibble of DROM data read from this address. Writing this register means reset watch dog timer if this timer is enabled by option. |
| Reserved | 1EH~<br>1FH | -   | xxxx | -      | -      | -      | -      | Reserved   |

Table 7: All of the Special Function Registers

# 5.4 Interrupt Vector Address

| Vector | Address |
|--------|---------|
| RESET  | 00H     |
| WAKEUP | 04H     |
| INT    | 08H     |

Table 8: Interrupt Vectors

# 5.5 Interrupt Controller

There is only one interrupt entry point in this chip. Normally interrupt period is 32768Hz. It can be changed to 65536Hz by option "PWM64K". Program will jump to address 0x008 when an interrupt occurs.

| Symbol   | Addr | R/W<br>type | Reset | D3       | D2       | D1    | D0    | Description   |
|----------|------|-------------|-------|----------|----------|-------|-------|---|
| STATUS   | 00H  | R/W         | 00xx  | reserved | PWFG     | CF    | / L   | Status Register PWFG: PWM interrupt flag. CF: Carry flag. ZF: Zero flag.              |
| PWM_CTRL | 09H  | R/W         | x0    | reserved | reserved | ENINT | ENPWM | <b>ENPWM:</b> "1" Enable PWM, "0" Disable PWM. <b>ENINT:</b> Enable global interrupt. |

Table 9: SFRs about Interrupt

If the global interrupt enable bit (INTEN) is high and interrupt request (PWFG=1) occurred, then interrupt will be accepted on next clock. On that instant, current (next) program counter, PCDH, MAH and C/Z will be stored in special hardware registers, and program counter will be loaded with entry address of that interrupt. All these are done in one clock. Interrupt enable bit will be cleared too. As long as program enters interrupt service, interrupt enable bit is cleared. It's no need to clear interrupt enable flag in interrupt routine. But hardware will not clear interrupt request flag (PWFG). Software is required to clear it.

When interrupt service routine is done, an RETI shall be executed. This instruction will restore stored program counter, PCDH, MAH and C/Z, will set interrupt enable bit=1 also. (Note that RETI is different from RETS.) Interrupt request can be accepted only when enable bit be set. Note that only one level of INT routine can be used.

# 5.6 Clock Operation

There are two operation modes in this chip. The state diagram of three MCU operation modes is shown below:

**1. NORMAL Mode**: In normal mode, system clock oscillator is running, and MCU clock source is come from main oscillator. In NORMAL mode, MCU will go to halt mode after HALT instruction executed.

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**2. HALT Mode**: In HALT mode, the MCU clock stops, users can't change the operation mode when in halt mode. It will go back to NORMAL mode (Program counter=0x004) when I/O wakeup or reset occurred. Please refer to the section of Halt Mode & Wake up for the detailed HALT mode description.

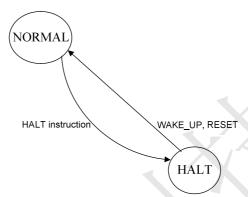


Figure 2: Clock Operation Mode

# 5.7 Halt Mode & Wake up

The MCU is changed into HALT mode (program counter and system clock stop) when HALT instruction executed. It provides a power saving mode for those applications requiring a very low stand-by current. The PA[3:0] are supporting the wake-up function when rising edge occurred.

The program counter will be 0x004 when HALT instruction executed immediately, then program counter will go to next address after 64 stable clock(system clock) when wake up condition occurred. Reset signal will release HALT state and execute reset procedure because reset is first priority when in HALT mode, so program counter will from 0x004 to 0x000, program counter goes to next address after 64 stable clock cycles. Furthermore, the SRAM will keep their previous data without changing in this mode.

# 5.8 Watch Dog Timer Reset (WDT)

The Watch Dog Timer (WDT) is used to reset whole chip when detect unexpected execution sequence caused by accident condition, avoiding dead lock of MCU program. WDT will be reset when wake-up from halt, after reset or software clears it. The watch dog timer is a simple counter. It has a fixed length of 256\*256\*16/system-clock (ex: 0.13 sec for 8.192MHz system clock) after the clearance of watch dog.

Software must run a "clear watch dog timer" (write to DMDH) instruction before this timer time out when WDT enabled. It will generate a reset signal to reset whole system when WDT over flow. Assembler will check user program about the "reset watch dog" instructions. If more than one "reset watch dog" is found in program, assembler will generate a warning (program code will still be generated). "HALT" instruction will reset watch dog timer. The reset watch dog timer sequence is strongly recommended as:

WATCHDOG:

LD (1DH), A

# 5.9 Low Voltage Detect (LVD)

The low voltage detect (LVD) function is used to detect whole chip power supply VCC. CST5006A support 16-level LVDS[3:0] to selected detect voltage level, the detected voltage range is from 3.8V to 2.1V.

There have one control register LVDEN used to enable/disable the low voltage detect function. The flag signal LVD\_FLAG is used to check the power supply VCC upper or under than low voltage detect level, when VCC upper than LVD level, the flag LVD\_FLAG value is low; otherwise, the flag LVD\_FALG value is high when VCC under than VCC.

| Symbol   | Addr | R/W<br>type | Reset | D3    | D2    | D1  | D0    | Description  |  |
|----------|------|-------------|-------|-------|-------|---|-------|--|--|
| LVD_CTRL | 13H  | R/W         | 0000  | -     | -     | LVD_FLAG: (Read only) The flag of LVD, '1'=LVD sensing. LVDEN: '1'=Enable LVD function, '0'=Disable LVD function. |       |  |  |
| LVDS     | 14H  | R/W         | 0000  | LVDS3 | LVDS2 | LVDS1   | LVDS0 | LVDS[3:0]: LVD level selected,<br>1111=3.8V, 1110=3.7V, 1101=3.6V, 1100=3.4V,<br>1011=3.3V, 1010=3.2V, 1001=3.1V, 1000=3.0V,<br>0111=2.9V, 0110=2.8V, 0101=2.7V, 0100=2.5V,<br>0011=2.4V, 0010=2.3V, 0001=2.2V, 0000=2.1V. |  |

#### 5.10 8/10/12 Bits PWM/DAC

There are three optional PWM/DAC output resolutions. One is 8-bits output, the sec. is 10-bits output, and the other is 12-bits output. The highest of input data is signed bit: '0' represents positive, '1' represents negative.

CST5006A supports audio output with PWM and DAC two modes. These two modes can be selected by "DACEN" option. If use DAC output mode, option "DACEN" must be enabled. Otherwise, PWM mode is enabled. All PWM registers will be exchanged for DAC mode if "DACEN" option is enabled.

| Symbol   | Addr | R/W<br>t | Reset | D3       | D2       | D1       | D0       | Description   |  |  |
|----------|------|----------|-------|----------|----------|----------|----------|---|--|--|
| STATUS   | 00H  | R/W      | 00xx  | reserved | PWFG     | CF       | 7F       | Status Register <b>PWFG:</b> PWM interrupt flag.  CF: Carry flag.  ZF: Zero flag.   |  |  |
| AUD_DLL  | 08Н  | W        | xxxx  | AUD_DLL3 | AUD_DLL2 | AUD_DLL1 | AUD_DLL0 | AUD_DLL[3:2]: The bit1~0 of 10-bits PWM, combine with AUD_DL[3:0], AUD_DH[3:0] to built 10-bits   |  |  |
| PWM_CTRL | 09H  | R/W      | x0    | reserved | reserved | ENINT    | ENPWM    | <b>ENPWM:</b> "1" Enable PWM, "0" Disable PWM. <b>ENINT:</b> Enable global interrupt.   |  |  |
| AUD_DL   | 0AH  | W        | xxxx  | AUD_DL3  | AUD_DL2  | AUD_DL1  | AUD_DL0  | AUD_DL[3:0]: The low nibble of 8-bits PWM. The bit5~2 of 10-bits PWM. The bit7~4 of 12-bits PWM.  |  |  |
| AUD_DH   | овн  | W        | xxxx  | AUD_DH3  | AUD_DH2  | AUD_DH1  | AUD_DH0  | AUD_DH[3:0]: The high nibble of 8 bits PWM. The bit9~6 of 10 bits PWM. The bit11~8 of 12 bits PWM. Note: AUD_DH3 is sign bit, "0" means positive. |  |  |

Table 10: SFRs about the operation of PWM



#### 5.10.1 8-Bits PWM/DAC

This PWM is 8-bits output resolution. An interrupt request happened when a PWM cycle completed.

The MSB of AUD DH is signed bit, '0' for positive, '1' for negative. PWM output frequency (sample rate) is fixed at 32KHz. PWM data registers are AUD\_DL, AUD\_DH. The AUL\_DL is low nibble (D3 ~ D0). AUD DH is high nibble (D7 ~ D4). D7 is the signed bit and D6 ~ D0 is the length (clock number) of output active pulse. Software should write AUD DL and AUD DH before enable PWM.

When an interrupt request happened, PWM interrupt flag bit PWFG of STATUS register will be "1". The PWM will load previously-written-data into actual conversion port on end of a PWM code output. So program can write data into PWM data store safely at beginning of an interrupt service routine. (A PWM interrupt means PWM data loaded, next data is expected). This timing shall be controlled carefully such that data writing in the beginning of interrupt service routine is safe. If data is not changed during a conversion, previous data will be used.

This PWM output can drive 8 ohm speaker. PWM can be enabled or disabled by setting/clearing ENPWM of PWM CTRL. When disabled, the PWMP, PWMN pins are all '0'. "HALT" instruction will disable PWM (clear ENPWM of PWM CTRL) and the PWMP and PWMN pins will be tri-state.

#### 5.10.2 10-Bits PWM/DAC

The frequency of PWM clock is fixed at 32 KHz if 10-bits PWM mode is selected by option. The 10-bits PWM data (AUD\_DH[3:0], AUD\_DL[3:0], AUD\_DLL[3:2]) are consist of AUD\_DH, AUD\_DL, AUD\_DLL three registers shown above. The data rage is 0 ~511. Software should write these registers before PWM is enabled. The other features of 10-bits PWM is the same as 8-bits PWM.

#### 5.10.3 12-Bits PWM/DAC

The frequency of PWM clock is fixed at 32 KHz if 12-bits PWM mode is selected by option "PWM12S". The 12-bits PWM data (AUD\_DH[3:0], AUD\_DL[3:0], AUD\_DLL[3:0]) are consist of AUD\_DH, AUD\_DL, AUD\_DLL three registers shown above. The data rage is 0 ~ 2047. Software should write these registers before PWM is enabled. The other features of 12-bits PWM is the same as 8-bits PWM.

Note: To avoid sound "Bo", please reference application note on web site.

#### 5.10.4 Speaker Provided a Wake-up Control Function

Normally, the PWMN and PWMP pin is tied to a speaker for playing music and a sound. This speaker connection structure can be used to wake-up MCU. If PWMWK is enabled, the speaker wake-up function is enabled after go into HALT mode and the PWM function keep operating in normal mode. If speaker wake-up function is enabled, the PWMP pin will be fixed to VSS level and PWMN pin also will be fixed to VSS level by chip.

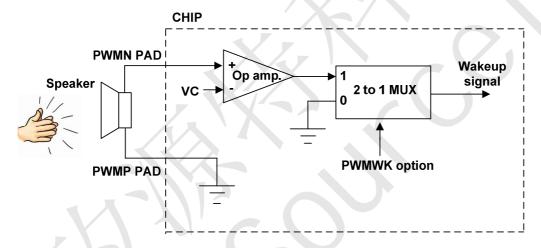
The signal level on PWMN pin will be changed (typically 0mV~10mV) when a sound receives from speaker. The MCU will be waked up if signal level on PWMN pin high enough. The relationship between wake-up signal and PWMN pin is shown in picture below. The wake-up signal goes high if PWMN pin larger than VC level and it goes low if PWMN pin smaller than VC level. Note:

- 1. This function consume about 5uA (VDD=5V) typically in HALT mode when "PWMWK" option is enabled.
- 2. PWM function must be keep silence about 200ms before go into HALT mode. Otherwise, MCU maybe keep in normal mode, not goes into HALT mode.

- 3. When PWMWK option enabled, PA0 wakeup option must be disabled, please referenced AN-
- 4. If ENGAIN enabled, option OPEN function should be disable.

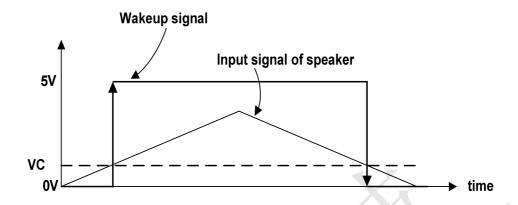
| Symbol | Addr | R/W<br>type | Reset | D3      | D2       | D1       | D0      | Description  |                 |  |
|--------|------|-------------|-------|---------|----------|----------|---------|--|-----------------|--|
| PWMWK  | 12H  | R/W         | 0000  | PWMWKFG | CLAPSEL1 | CLAPSEL0 | PWMWKEN | be set by hardwa<br>software.<br>PWMWKEN: Wak<br>1: Enable PWM w<br>0: Disable PWM w | akeup function. |  |

Table 13: SFRs about the operation of speaker wakeup function



Wakeup control block diagram and speaker trigger application circuit

Figure 3: Speaker wakeup structure



Input signal of speaker vs. Wakeup signal waveform

Figure 4: Speaker wakeup waveform

Notice: Speaker wakeup function, please reference application note "AN-0068 V1.0" on web site.

# 5.11 Reset Function

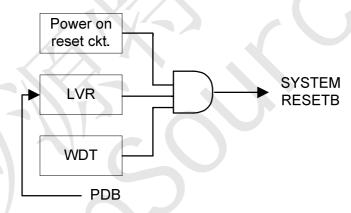


Figure 5: Reset structure

The system reset is come from three signals which are Power on reset, Low voltage reset(LVR) and WDT overflow reset.

For normal operation of this chip, a good reset is needed. The operation frequency of MCU will go back to normal mode when reset occurred in HALT mode.

# 5.12 System Clock Oscillator

This chip MCU is typically operated on 8.192MHz which is generated from internal RC oscillator 32MHz.

#### 5.13 I/O Ports

There is one I/O port PA3~PA0, whose input/output direction are defined by IOC PA. The wake-up functions of PA3~PA0 are enabled or disabled by option. All I/O ports provides rising or falling edge wake up function. This double edge wake up function can be enabled by "BIWK" option. Their 1M/50K Ohm pull down resistors are optional.

In order to achieve touch function, CST5018A support 220K Ohm pull down resistors. These resistors can be enabled by using 50K Ohm pull down resistor registers after "PD220K" is enabled. The 220K Ohm resistance value is almost fixed value when VCC change from 2.0V to 5.5V.

# 5.13.1 Port PA (input/output)

The Port A is 4-bits bidirectional I/O port. Their directions can be defined by IOC PA bit by bit. The following table describe the SFRs associated with Port A.

| Symbol  | Addr | R/W<br>type | Reset | D3    | D2    | D1    | D0       | Description   |
|---------|------|-------------|-------|-------|-------|-------|----------|---|
| IOC_PA  | 02H  | R/W         | 0000  | IOCA3 | IOCA2 | IOCA1 | IOCA0    | "1" = output, "0" = input of related PA bit.          |
| DATA_PA | 03H  | R/W         | xxxx  | DPA3  | DPA2  | DPA1  | I DPAO / | Read from Port A input port and write to output port. |

Table 14: SFRs of Ports PA

In output mode, the data can be written out to external pin, and reading this output port will read the data internal latch. Pull-down resistor will be disabled when output mode is selected.

In input mode, Port A data can be read from external pin, and they are attached with 1M/50K Ohm pull-down resistor or not according to the options.

In addition, each pin of Port A also can be accompanied with wake-up function according to the options. In HALT mode, if some bits of Port A are accompanied with wake-up function, any rising edge occurred on that pin will wake up system and turn on oscillator, and the program counter of MCU will jump to the address 0x004. This device will start to execute the wake-up sub-routing.

#### PA3 is provided with 38KHz modulator

I/O port PA3 built-in a 38KHz modulator combined with register DATA PA bit-3, this function is enabled by "F38K" option. If F38K option is enabled, I/O port PA3 will output 38KHz clock signal when PA3 is configured as output port and DATA PA bit-3 = 1. PA3 output low when PA3 is configured as output port and DATA PA bit-3 = 0.

Notice: The PA3 output pad will be forced to low state automatically by hardware control when in halt mode for avoid external IR LED destroyed. Besides, the F38K option disabled, PA3 is a normal I/O port.

# PA0 is provided with an analog input (Schmitt) for wake-up control

PA0 supports an analog input buffer with Schmitt circuit, it is enabled by "RCWK" option and supports low power consumption in halt mode, if PA0 analog signal keep about 0.5\*VCC, so this function is suitable for recycle wakeup MCU by external RC time constant, external RC time constant is easy built by VCC connected to R and serial with C to VSS.

The block diagram and electrical characteristic of PA0 analog input buffer shown below. It takes about 5uA when PA0 input signal is 2.5v @VCC=5V in halt mode, otherwise, it takes about 500uA current if RCWK option disabled. This block function is enabled when RCWK option enabled by hardware after power on reset.

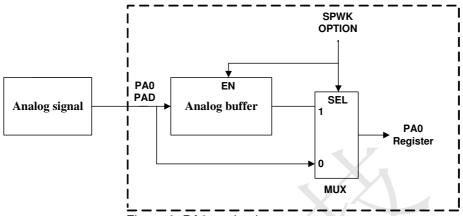


Figure 6. PA0 analog input structure

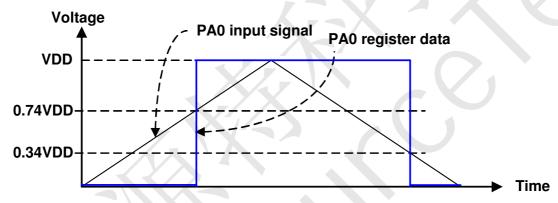


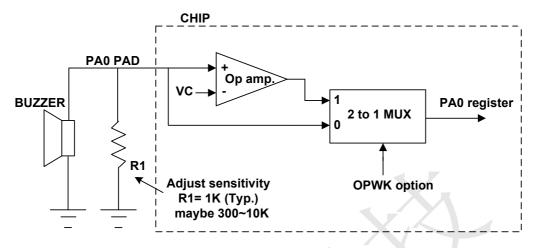
Figure 7. PA0 input signal and PA0 register data

# PA0 is provided with an analog input (OP Amp.) for wake-up control

It built-in an OP amplifier for wake-up trigger, the pull down 1M and 50K Ohm resistor will be disabled by hardware circuit when "**BZWK**" option is enabled automatically, PA0 always keep at DC level (bias voltage Vbias) for signal amplify, and Vbias is about 0.8V~1.0V. (Wake-up by analog signal amplifier function is enabled by mask option "**BZWK**")

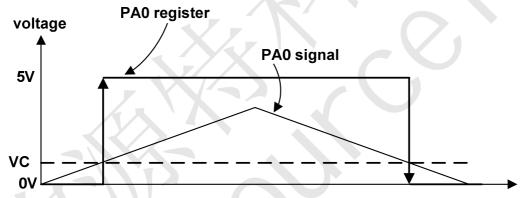
This block function is enabled when BZWK option is enabled by hardware after power on reset. Notice: Buzzer function, please reference application note "AN-0068 V1.0" on web site.

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PA0 analog wakeup block diagram and buzzer trigger application circuit

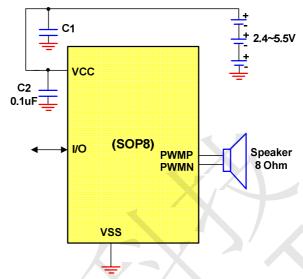
Figure 8. PA0 buzzer wake up structure



PA0 analog wakeup input signal vs. PA0 register waveform

Figure 9. PA0 register waveform

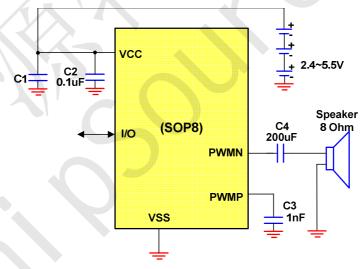
# 6. CST5006A The Application Circuit



Note: Substrate must be connected to VSS.

Figure 10. PWM Applications circuit

# **DAC Selected by option**



Note: Substrate must be connected to VSS.

Figure 11. DAC Applications circuit

#### Notice:

- 1. Regarding recording or remote car applications, please reference application note on web site.
- 2. C1: 47 uF ~ 100 uF(depends on applications), C2: 0.1 uF
- 3. DAC Applications circuit not support PWM wakeup function.
- 4. DAC Applications, please reference application note on web site.

# 7. CST5006A Option Registers table

| Option Name | Function Description                                 |
|-------------|--|
| BZWK        | PA0 buzzer trigger wakeup                            |
| RCWK        | PA0 RC wakeup  |
| PWM64K      | PWM int. freq. select                                |
| DACEN       | DAC function control                                 |
| WAKEBA      | Wake-up enable for PA3~PA0 respectively              |
| PD50KPA     | 50K Ohm pull down resistor for PA3~PA0 respectively. |
| PD1MPA      | 1M Ohm pull down resistor for PA3~PA0 respectively.  |
| WDGENB      | Watch dog timer                                      |
| HALTENB     | HALT mode control                                    |
| PD220K      | Change 50K Ohm pull-down resistor to 220K Ohm        |
| PWM12S      | PWM 12 bit select                                    |
| PWM10S      | PWM 10/8 bit select                                  |
| OTPLOCK     | Security control                                     |
| F38K        | PA3 38KHz output                                     |
| BIWK        | Bi-directional wake up                               |
| OPTADJ      | OSC IADJ select                                      |
| HDEN        | Driving capacity of output port control              |

# 8. CST5006A The Revision History

| Version |             | Description | Page | Date       |
|---------|-------------|-------------|------|------------|
| 1.0     | Established | X \ \ \     |      | 2021-01-04 |

Table 15: Revision History